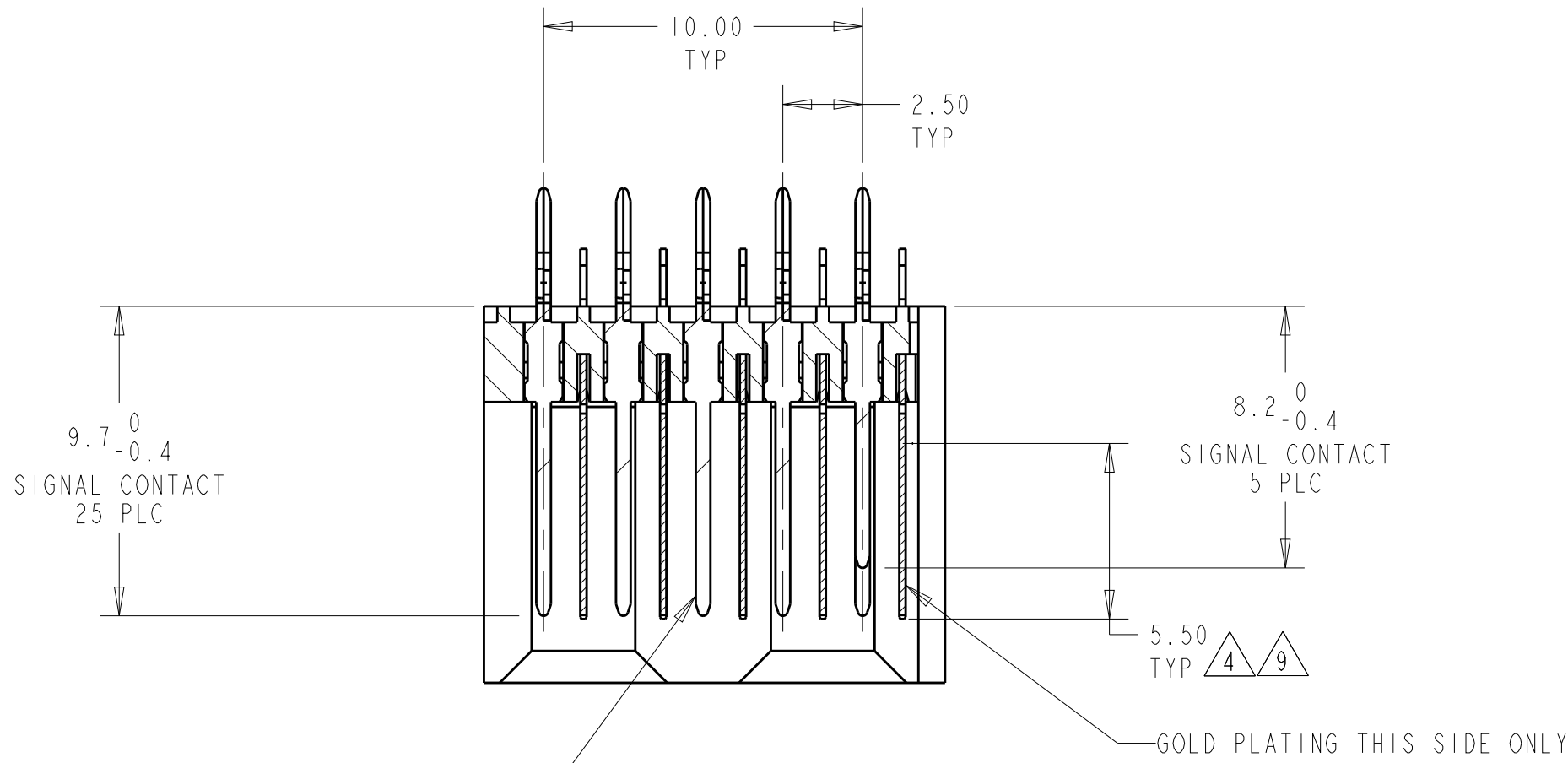
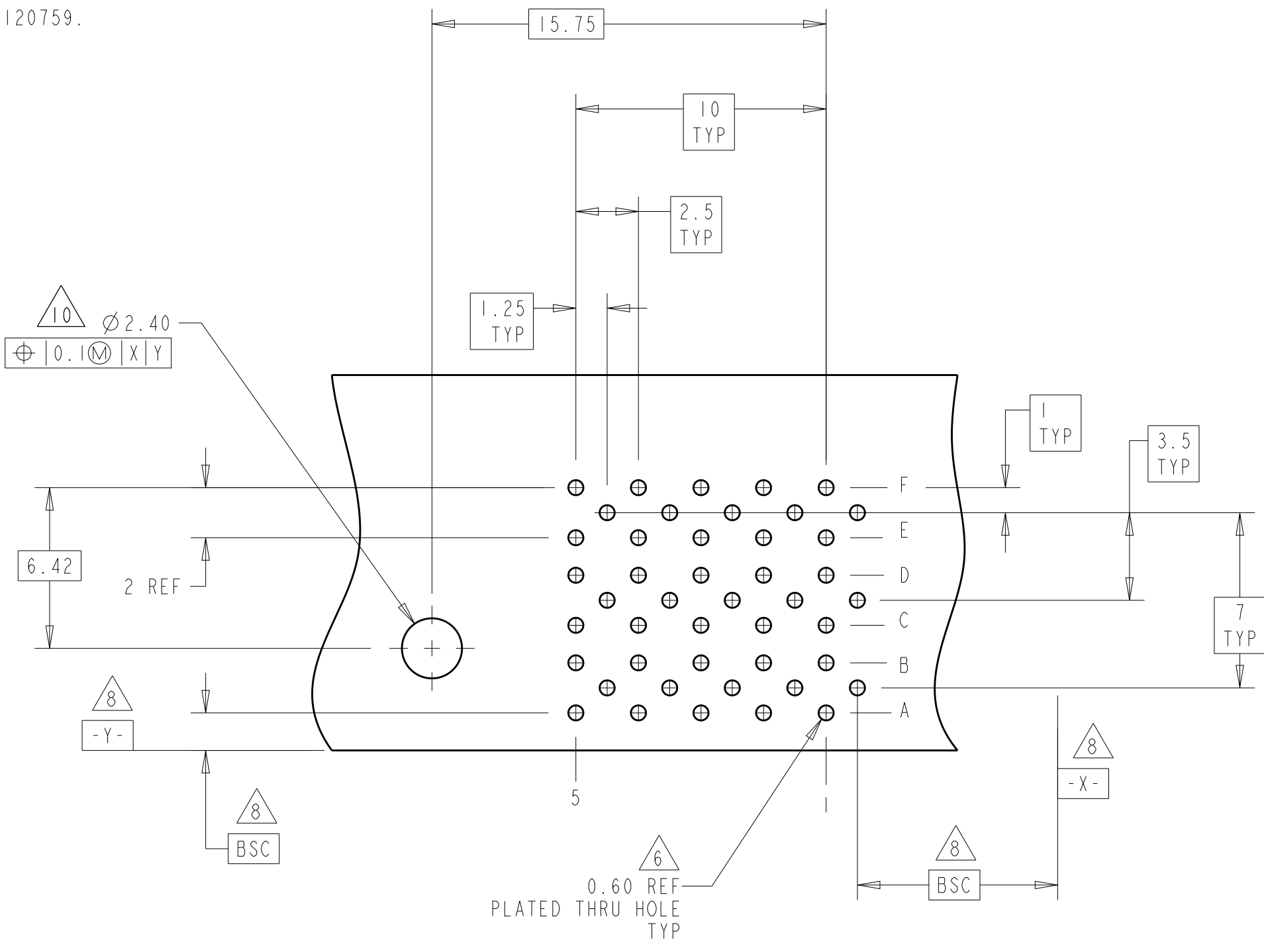
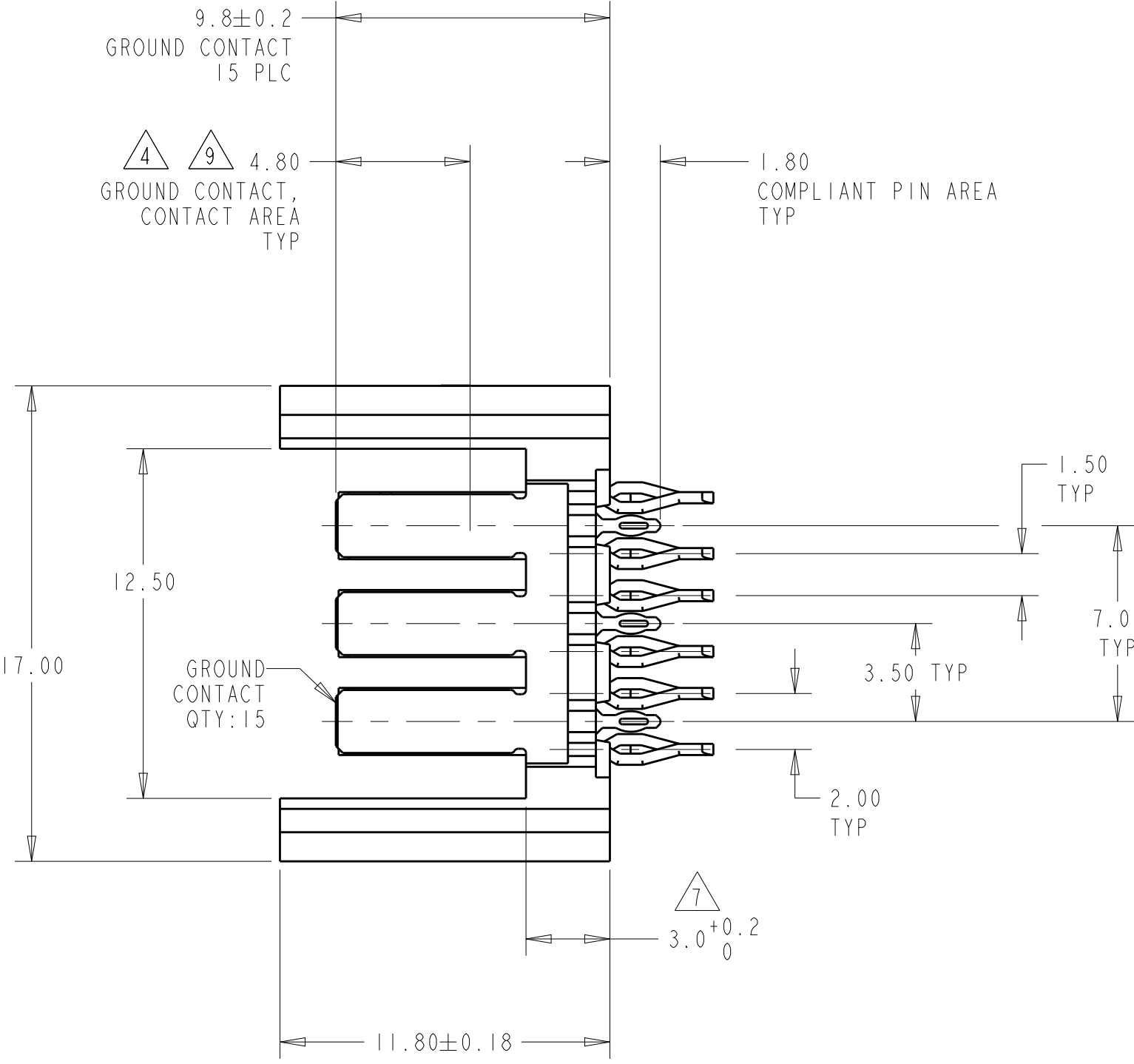
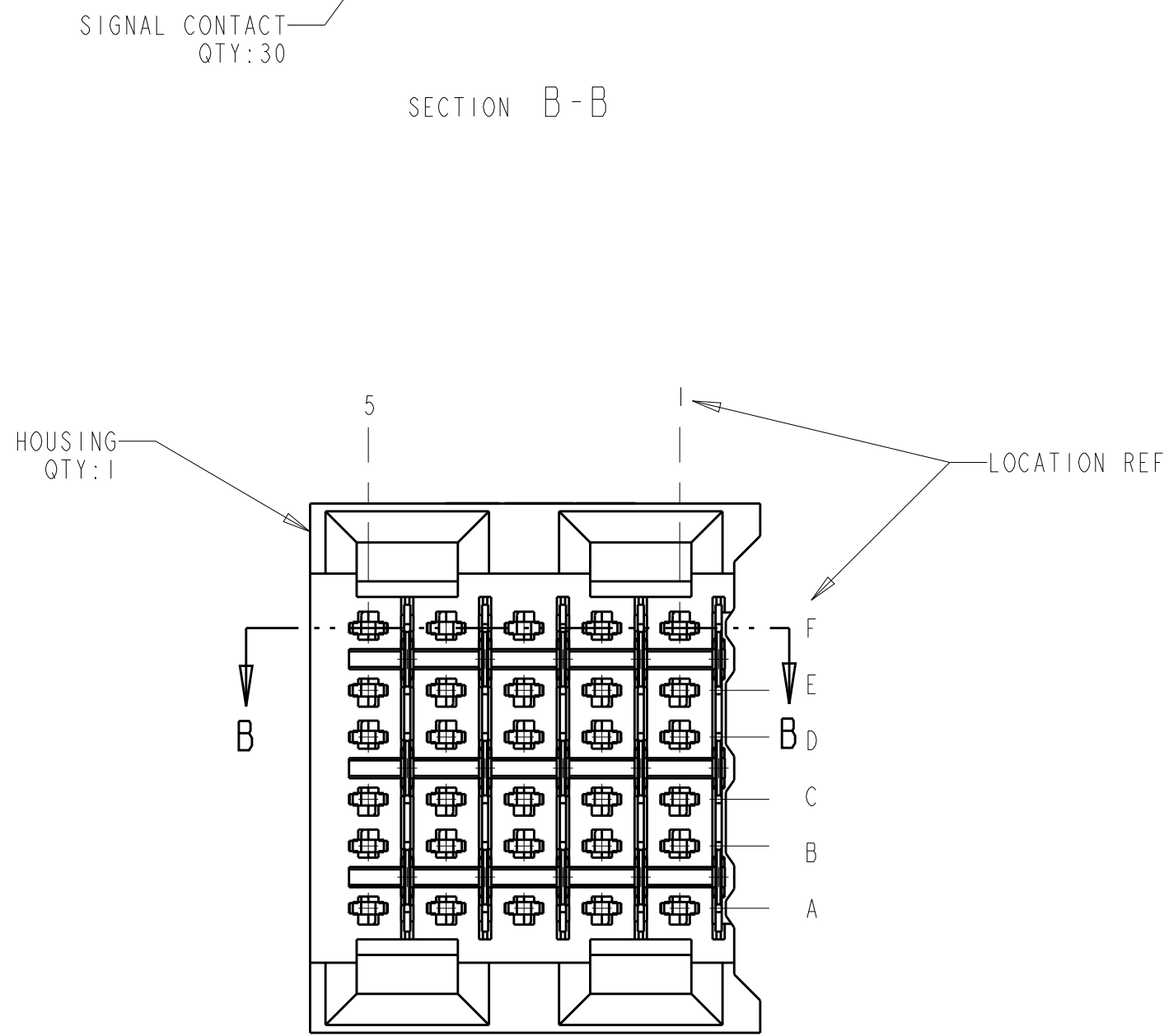


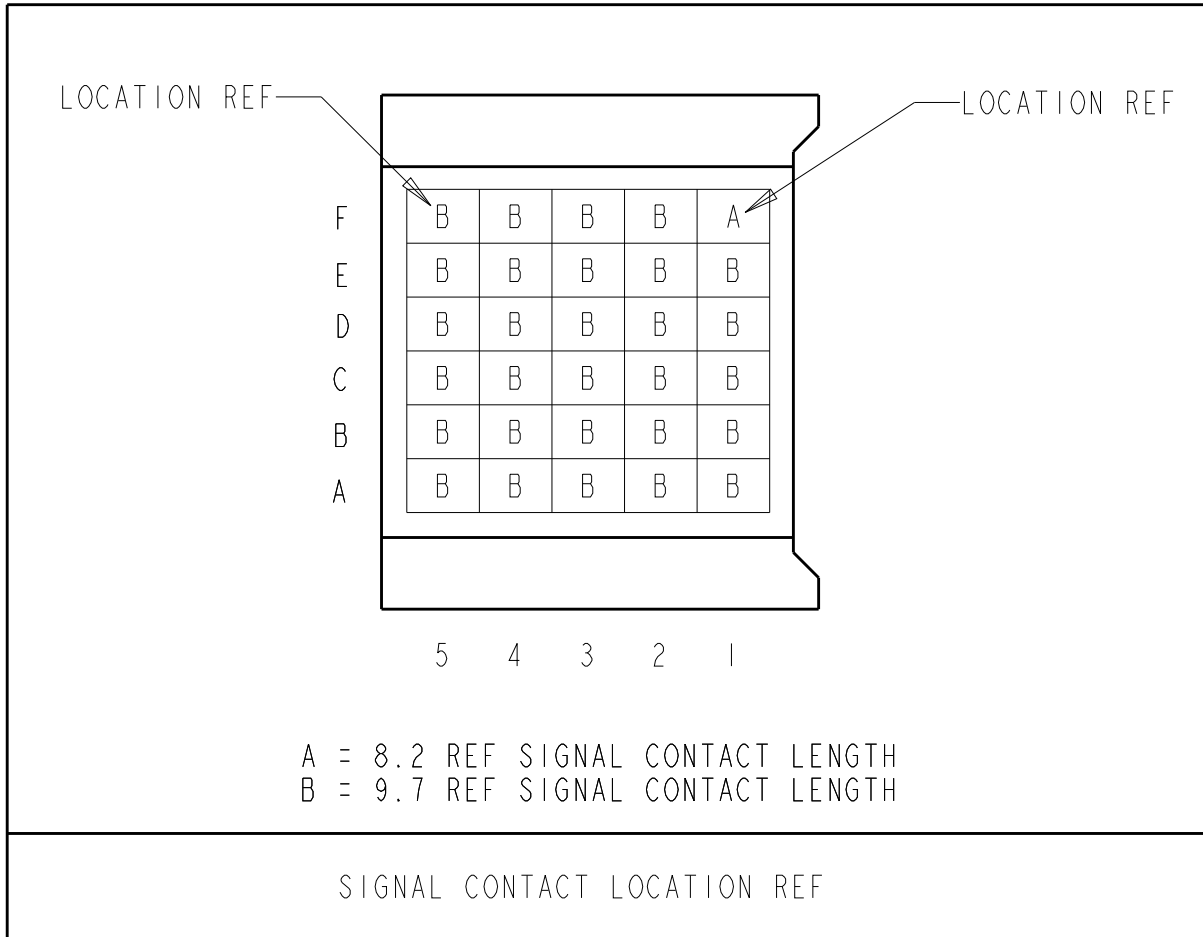
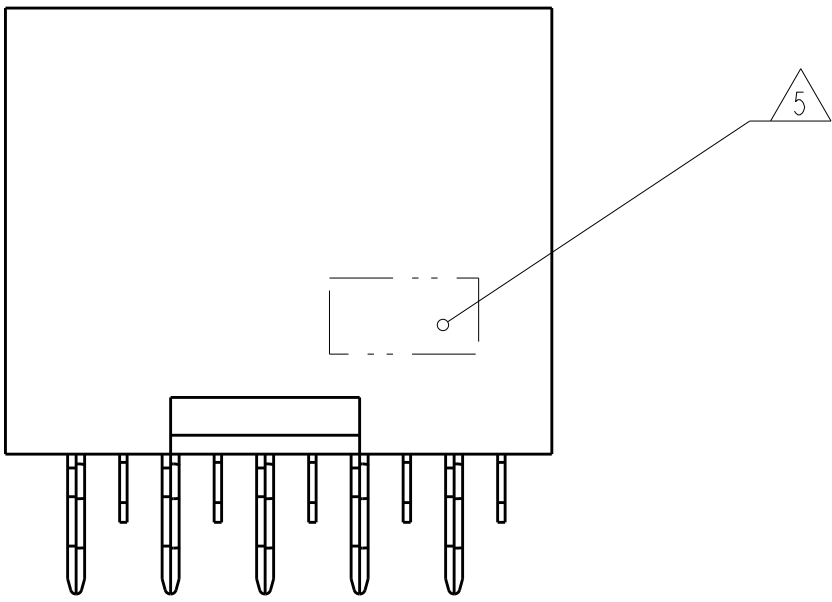
LOC		DIST		REVISIONS				
P	LTR	DESCRIPTION			DATE	DWN	APVD	
	A	RELEASED			24SEP2012	-	JE	



- 2 PHOSPHOR BRONZE
- 3 LCP, UL94V-0
- 4 FINISH:
CONTACT MATING AREA MEETS THE PERFORMANCE REQUIREMENTS OF
TE CONNECTIVITY PRODUCT SPECIFICATION 108-1957; BASED ON
TELCORDIA GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS.
COMPLIANT PIN AREA: 0.5µm MIN MATTE TIN OVER BASE PLATING.
- 5 CONNECTOR MARKED WITH PART NUMBER AND DATE CODE.
- 6 REFERENCE APPLICATION SPEC 114-13020 FOR
RECOMMENDED PLATED THRU HOLE DIAMETER AND
PLATING THICKNESS.
- 7 APPLICATION SEATING HEIGHT TO PRINTED CIRCUIT BOARD.
- 8 DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER.
- 9 CONTACT AREA LUBRICATED WITH BELLCORE APPROVED LUBRICANT.
TECHNICAL REFERENCE: GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- 10 HOLE DIAMETER SHOULD BE 3.10 WHEN USING FEED THROUGH GUIDE PIN P/N 120759.
CLEARANCE FOR M3x0.5 THREAD.



RECOMMENDED
PRINTED CIRCUIT BOARD
LAYOUT
COMPONENT SIDE OF PRINTED CIRCUIT BOARD



ROWS A,B,C,D,E ROW F: 2-5	ROW F: 1	5120993-1
SIGNAL CONTACT TYPE B QTY: 29 9.7 LENGTH REF	SIGNAL CONTACT TYPE A QTY: 1 8.2 LENGTH REF	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.			DWN B. CARRO 26JUL2006		 TE Connectivity	
DIMENSIONS:			CHK R. PATTERSON 26JUL2006			
mm			APVD R. PATTERSON 26JUL2006		NAME	
			PRODUCT SPEC		HEADER ASSEMBLY, 30 POSITION, SEQUENCED, RIGHT HAND, 6 ROW, Z-PACK HS3	
			APPLICATION SPEC			
			WEIGHT			
			Customer Drawing			
			SCALE 5:1			
			SHEET 1 OF 1		REV A	